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JUL 2 1 2005 - INFORMATION DISCLOSURE	PLICANT nn J. Leedy	CONFIRMATION NO. 3092
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EXAMINE	DOCUMENT		U.S. PATENT DOCUMENT			FILING DATE
R INITIAL	NUMBER	DATE	NAME	CLASS	SUBCLASS	IF APPROPRIATE
	Re. 34,893	04/04/95	Fujii et al.	257	419	
	2,915,722	12/01/59	Foster	336	115	
	3,202,948	08/24/65	Farrand	336	115	
	3,559,282	02/02/71	Lesk	438	113	
	3,560,364	02/02/71	Burkhardt	324	207.12	
	3,602,982	09/07/71	Emmasingel	29	577	
	3,615,901	10/26/71	Medicus	148	11.5 R	
	3,716,429	02/13/73	Napoli et al.	156	17	
	3,777,227	12/14/73	Krishna et al.	257	578	
	3,868,565	02/25/75	Kuipers	324	207.26	
	3,922,705	11/25/75	Yerman	357	26	
	3,997,381	12/14/76	Wanlass	156	3	
	4,070,230	01/24/78	Stein	156	657	
	4,131,985	01/02/79	Greenwood et al.	29	580	
	4,142,004	02/27/79	Hauser, Jr. et al.	438	792	
	4,251,909	02/24/81	Hoeberechts	29	580	
	4,262,631	04/21/81	Kubacki	118	723MP	
	4,394,401	07/19/83	Shioya et al.	427	574	
	4,401,986	08/30/83	Trenkler et al.	340	870.32	
	4,416,054	11/22/83	Thomas et al.	29	572	
	4,539,068	09/03/85	Takagi et al.	156	614	
	4,585,991	04/29/86	Reid et al.	324	158 P	
	4,612,083	09/16/86	Yasumoto et al.	156	633	
	4,617,160	10/14/86	Belanger et al.	264	40.1	
	4,618,397	10/21/86	Shimizu et al.	156	628	
	4,618,763	10/21/86	Schmitz	250	211R	·
	4,663,559	05/05/87	Christensen	313	336	
	4,684,436	08/04/87	Burns et al.	216	65	
YESY .	4,693,770	09/15/87	Hatada	156	151	

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DATE CONSIDERED 1/2/05

FORM PTO-1449  U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE					TTY. DOC LM-1 Cont		APPLICATION NO. 10/766,557
	INFORMATION STATEMEN				PPLICANT lenn J. Le		CONFIRMATION NO. 3092
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POD TO	4,702,336	10/27/87	Maeda et al.	·	180	197	
<del></del>	4,702,936	10/27/87	Seibert et al.		427	583	
	4,706,166	11/10/87	Go		361	403	
	4,721,938	01/26/88	Stevenson		338	4	
	4,761,681	08/02/88	Reid		357	68	
	4,784,721	11/15/88	Holmen et al.		156	647	
	4,810,673	03/07/89	Freeman		438	386	
	4,825,277	04/25/89	Mattox et al.		257	639	
. /	4,857,481	08/15/89	Tam et al.		438	619	
7	4,924,589	05/15/90	Leedy		438	6	
7	4,940,916	07/10/90	Borel et al.		313	306	
	Re B14,940,916	11/26/96	Borel et al.		315	306	
11	4,950,987	08/21/90	Vranish et al.		324	207.23	
	4,952,446	08/18/90	Lee et al.		428	220	
	4,954,865	09/04/90	Rokos		257	378	
	4,957,882	09/18/90	Shinomiya		438	65	
	4,965,415	10/23/90	Young et al.		200	83 N	
	4,966,663	10/30/90	Mauger		205	656	
	4,994,735	02/19/91	Leedy		324	158	
	5,008,619	04/16/91	Keogh et al.		324	207.17	
	5,010,024	04/23/91	Allen et al.		438	659	
	5,020,219	06/04/91	Leedy		29	846	
	5,034,685	07/23/91	Leedy	一	324	158 F	
	5,070,026	12/03/91	Greenwald et al.		437	3	
	5,071,510	12/10/91	Findler et al.		156	647	
	5,098,865	03/24/92	Machado et al.		438	788	
	5,103,557	04/14/92	Leedy		29	832	
$\Lambda L$	5,110,373	05/05/92	Mauger		148	33.2	
	5,111,278	05/05/92	Eichelberger		357	75	
	5,116,777	05/26/92	Chan et al.		438	234	
A .	5,130,894	07/14/92	Miller		361	393	
HEP	5,132,244	07/21/92	Roy		438	477	

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FORM PTO		. DEPARTMEN <sup>*</sup> TENT AND TRA	ATTY. DO ELM-1 Co	CKET NO. nt. 14	APPLICATION NO. 10/766,557		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT				APPLICAI Glenn J. L		CONFIRMATION NO. 3092	
	F			FILING DA January 2		GROUP 2812	
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FED	5,151,775	09/29/92	Hadwin	357	80		
1	5,156,909	10/20/92	Henager, Jr. et al.	428	334		
	5,203,731	04/20/93	Zimmerman	445	24	_	
	5,225,771	07/06/93	Leedy	324	158		
	5,236,118	08/17/93	Bower et al.	228	193		
7	5,262,351	11/16/93	Bureau et al.	437	183		
	5,270,261	12/14/93	Bertin et al.	437	209		
T	5,273,940	12/28/93	Sanders	437	209		
	5,274,270	12/28/93	Tuckerman	257	758		
	5,279,865	01/18/94	Chebi et al.	427	574		
	5,284,796	02/08/94	Nakanishi et al.	437	183		
	5,323,035	06/21/94	Leedy	257	48		
	5,324,687	06/28/94	Wojnarowski	437	225		
	5,354,695	10/11/94	Leedy	438	411		
	5,363,021	11/08/94	MacDonald	315	366		
	5,385,909	01/31/95	Nelson et al.	514	291		
	5,385,632	01/31/95	Goossen	156	630		
	5,420,458	05/30/95	Shimoji	257	622		
	5,424,920	06/13/95	Miyake	361	735		
	5,426,072	06/20/95	Finnila	437	208		
	5,426,363	06/20/95	Akagi et al.	324	239		
	5,432,444	07/11/95	Yasohama et al.	324	240		
	5,432,729	07/11/95	Carson et al.	365	63		
	5,434,500	07/18/95	Hauck et al.	324	67		
	5,451,489	09/19/95	Leedy	430	313		
	5,453,404	09/26/95	Leedy	437	203		
	5,457,879	10/17/95	Gurtler et al.	29	895		
	5,476,813	12/19/95	Naruse	437	132		
	5,489,554	02/06/96	Gates	437	208		
7	5,502,667	03/26/96	Bertin et al.	365	51		
	5,512,397	04/30/96	Leedy	430	30		
YEST	5,527,645	06/18/96	Pati et al.	430	5		

DATE CONSIDERED

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FORM PTO			T OF COMMERCE DEMARK OFFICE	ATTY. DO		APPLICATION NO. 10/766,557
INFORMATION DISCLOSURE STATEMENT BY APPLICANT				APPLICAN Glenn J. Le		CONFIRMATION NO. 3092
				FILING DA January 27		GROUP 2812
THE D	5,529,829	06/25/96	Koskenmaki et al.	428	167	
1	5,534,465	07/09/96	Frye et al.	437	209	
	5,555,212	09/10/96	Toshiaki et al.	365	200	
	5,563,084	10/08/96	Ramm et al.	437	51	
	5,571,741	11/05/96	Leedy	437	51	
	5,580,687	12/03/96	Leedy	430	5	
	5,581,498	12/03/96	Ludwig et al.	365	63	
	5,582,939	12/10/96	Pierrat	430	5	
	5,583,688	12/10/96	Hornbeck	359	291	
Ì	5,592,007	01/07/97	Leedy	257	347	
	5,592,018	01/07/97	Leedy	257	619	
1	5,595,933	01/21/97	Heijboer	439	20	
	5,606,186	02/25/97	Noda	257	226	
	5,627,112	05/06/97	Tennant et al.	438	113	
	5,629,137	05/13/97	Leedy	430	313	
	5,633,209	05/27/97	Leedy	435	228	
	5,637,536	06/10/97	Val	438	686	
	5,654,127	08/05/97	Leedy	430	315	
	5,654,220	08/05/97	Leedy	438	25	
	5,656,552	08/12/97	Hudak et al.	438	15	
	5,675,185	10/07/97	Chen et al.	257	774	
	5,694,588	12/02/97	Ohara et al.	395	566	
	5,725,995	03/10/98	Leedy	430	315	
	5,750,211	05/12/98	Weise et al.	427	579	
	5,760,478	06/02/98	Bozso et al.	257	777	
	5,773,152	06/30/98	Okonogi	428	446	
	5,786,116	07/28/98	Rolfson	430	5	
	5,793,115	08/11/98	Zavracky et al.	257	777	
	5,831,280	11/03/98	Ray	257	48	
	5,834,334	11/10/98	Leedy	438	107	
	5,840,593	11/24/98	Leedy	438	6	
404	5,856,695	01/05/99	ito et al.	257	370	

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DATE CONSIDERED 1/21/05

FORM PTO-1449  U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE  INFORMATION DISCLOSURE					ATTY. DOC		APPLICATIO 10/766,557	N NO.	
						APPLICANT Glenn J. Lee		CONFIRMAT 3092	TION NO.
STATEMENT BY AP			PLICANT	LICANT			E 2004	GROUP 2812	
FEP	5,868,949	02/09/	99 Sotok	awa et al.		216	18		
	5,869,354	02/09/		,	•	438	110		
	5,870,176	02/09/	99 Swea	tt et al.		355	53		
	5,880,010	03/09/	99 David	son		438	455		
	5,882,532	03/16/	99 Field	et al.		216	2		•
	5,902,118	05/11/	99 Hübn	er		438	106		
	5,915,167	06/22/	99 Leedy	,		438	108		
	5,946,559	08/31/	99 Leedy	·		438	157		
	5,985,693	11/16/	99 Leedy	,		438	107		
	5,998,069	12/07/	99 Cutte	<del></del>		430	5		
	6,008,126	12/28/	99 Leedy			438	667		
	6,020,257	02/01/	00 Leedy	1		438	626		
	6,045,625	04/04/	00 Houst	on		148	33.3		
	6,084,284	07/04/	00 Adam	ic, Jr.		257	506		
	6,097,096	08/01/	00 Gardr	er et al.		257	777		
	6,133,640	10/17/	00 Leedy	,		257	778		
	6,194,245 B1	02/27/	01 Tayar	aka		438	57		
	6,197,456 B1	03/06/	01 Alesh	in et al.		430	5		
	6,208,545 B1	03/27/	01 Leedy			365	51		
	6,236,602 B1	05/22/	01 Patti			365	201		
	6,261,728 B1	07/17/				430	30		
/	6,288,561 B1	09/11/	01 Leedy	· ·		324	760		
PEP	6,294,909 B1	09/25/	01 Leedy			324	207.17		
			FOREIGN	PATENT DO	CUME	NTS			
EXAMINER INITIAL	DOCUMENT NU	MBER	DATE	COUNT	RY	CLASS	SUBCLAS	S TRANS	LATION NO
70	WO 98/19337		05/1998	PCT	<del> </del>	H01L	21/44		1
860	GB 2,215,168		09/1989	UK		309G	1/00		
AD.	EP 0 189 976		08/1986	EPO		H01L	31/18		1
क्व	EP 0 731 525		09/1996	EPO	1	101P	5/00		
"FOP	2641129		12/1988	France		H01L	39/04		
POP	JP 60-74643		04/1985	Japan	<del></del>		1	ABST	

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	APPLICANT Glenn J. Leed	CONFIRMATION NO. 3092					
STATEMENT BY APPLICANT				FILING DATE January 27, 20		GROUP 2812	
120							
1.00	JP 02-082564	03/1990	Japan			ABST	
TO TO	JP 04-083371	03/1992	Japan			ABST	
PO	JP 04-107964	04/1992	Japan			ABST	r l
ROD	JP 402027600A 01/1990 Japan					ABST	г

•	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)
EXAMINER INITIAL	
POP	"IC Tower Patent: Simple Technology Receives Patent on the IC Tower, a Stacked Memory Technology," <a href="http://www.simpletech.com/whatsnew/memory/@60824.htm">http://www.simpletech.com/whatsnew/memory/@60824.htm</a> (1998).
A A	Alloert, K., et al., "A Comparison Between Silicon Nitride Films Made by PCVD of N <sub>2</sub> -SiH <sub>4</sub> /Ar and N <sub>2</sub> -SiH <sub>4</sub> /He," <i>Journal of the Electrochemical Society</i> , Vol. 132, No. 7, pp. 1763-1766, (July 1985).
Pap	Hendricks, et al., "Polyquinoline Coatings and Films: Improved Organic Dielectrics for IC's and MCM's," Eleventh IEEE/CHMT International Electronics Manufacturing Technology Symposium," pp. 361-265 (1991).
Pop	Knolle, W.R., et al., "Characterization of Oxygen-Doped, Plasma-Deposited Silicon Nitride," <i>Journal of the Electrochemical Society</i> , Vol. 135, No. 5, pp. 1211-1217, (May 1988).
POS	Nguyen, S.V., "Plasma Assisted Chemical Vapor Deposited Thin Films for Microelectronic Applications, J. Vac. Sci. Technol. Vol. B4, No. 5, pp.1159-1167, (Sep/Oct. 1986).
Pop	Olmer, et al., "Intermetal Dielectric Deposition by Plasma Enhanced Chemical Vapor Deposition," Fifth IEEE/CHMT International Electronic Manufacturing Technology Symposium - Design-to-Manufacturing Transfer Cycle," pp. 98-99 (1988).
Poo	Runyan, W.R., "Deposition of Inorganic Thin Films," Semiconductor Integrated Circuit Processing Technology, p. 142 (1990).
POP	Sze, S.M., "Surface Micromachining," Semiconductor Sensors, pp. 58-63 (1994).
PSD	Vossen, John L., "Plasma-Enhanced Chemical Vapor Deposition," <i>Thin Film Processes II</i> , pp. 536-541 (1991).
PA	Wolf, Stanley, "Basics of Thin Films," Silicon Processing for the VLSI Era, pp. 115, 192, 193, and 199 (1986).

DATE CONSIDERED

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FORM PTO-1449	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. ELM/001 Cont. 14	APPLN. NO. 10/766,557
	ENTAL INFORMATION DISCLOSURE FATEMENT BY APPLICANT	APPLICANTS Glenn J. Leedy	CONF. NO. 3092
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### **U.S. PATENT DOCUMENTS**

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
H	4,500,905	02/19/1985	Shibata	357	68	
	4,939,568	07/03/1990	Kato, et al.	357	75	
	4,892,753	01/09/1990	Wang, et al.	427	579	
	5,000,113	03/19/1991	Wang, et al.	118	723	
	5,240,458	08/31/1993	Linglain, et al.	464	63	
	5,259,247	11/09/1993	Bantien	73	718	
	RE 34,893	04/04/1995	Fujii, et al.	257	419	
	RE 36,623	03/21/2000	Wang, et al.	427	579	
	6,087,284	07/11/2000	Brix, et al.	501	69	
787	6,518,073	02/11/2003	Momohara	438	4	12/10/2001

# **FOREIGN PATENT DOCUMENTS**

A TRADEMARK OF

EXAMINER	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLAT	ION
INITIAL	NOMBER	OMBER				YES	NO
	04-196,263	07/1992	Japan				

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

EXAMINER INITIAL	g and
FB	Aboaf, J.A., "Stresses in SiO <sub>2</sub> Films Obtained from the Thermal Decomposition of Tetraethylorthosilicate – Effect of Heat Treatment and Humidity," J. Electrochem. Soc.: Solid State Science; 116(12): 1732-1736 (Dec. 1969).
POP	Scheuerman, R.J., "Fabrication of Thin Dielectric Films with Low Internal Stresses," J. Vac. Sci. and Tech., 7(1): 143-146 (1970).
PP	Bailey, R., "Glass for Solid-State Devices: Glass film has low intrinsic compressive stress for isolating active layers of magnetic-bubble and other solid-state devices," NASA Tech Brief (1982).
POP	"Partitioning Function and Packaging of Integrated Circuits for Physical Security of Data," IBM Technical Disclosure Bulletin, IBM Corp.; 32(1): 46-49 (June 1989).
POP	Hsieh, et al., "Directional Deposition of Dielectric Silicon Oxide by Plasma Enhanced TEOS Process," 1989 Proceedings, Sixth International IEEE VLSI Multilevel Interconnection Conference, pp. 411-415 (1989).
PEP	Tessier, et al., "An Overview of Dielectric Materials for Multichip Modules," SPE, Electrical & Electronic Div.; (6): 260-269 (1991).

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DATE CONSIDERED 1/21/05

FORM PTO-1449	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. ELM/001 Cont. 14	APPLN. NO. 10/766,557
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT		APPLICANTS Glenn J. Leedy	CONF. NO. 3092
		FILING DATE January 27, 2004	GROUP ART UNIT

	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)
EXAMINER INITIAL	
RO	Treichel, et al., "Planarized Low-Stress Oxide/Nitride Passivation for ULSI Devices," J. Phys IV, Colloq. (France), 1 (C2): 839-846 (1991).
R	Krishnamoorthy, et al., "3-D Integration of MQW Modulators Over Active Submicron CMOS Circuits: 375 Mb/s Transimpedance Receiver –Transmitter Circuit," IEEE Photonics Technology Letters, 2(11): 1288-1290 (November 1995).
Pop	Tielert, et al., "Benefits of Vertically Stacked Integrated Circuits for Sequential Logic," IEEE, XP-000704550, 121-124 (December 5, 1996).
Co Co	"Miniature Electron Microscopes Without Vacuum Pumps, Self-Contained, Microfabricated Devices with Short Working Distances, Enable Operation in Air," NASA Tech Briefs, 39-40 (1998).
120	Partial European Search Report for Application No. EP 02009643 (October 8, 2002)

DATE CONSIDERED

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## **U.S. DEPARTMENT OF COMMERCE** PATENT AND TRADEMARK OFFICE

#### ATTY. DOCKET NO. APPLN. NO. ELM/001 Cont. 14 10/766,557 CONF. NO. **APPLICANTS** 3092 Glenn J. Leedy **FILING DATE GROUP ART UNIT** 2812 January 27, 2004

### SECOND SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT

### **U.S. PATENT DOCUMENTS**

EXAMINE INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE			
TEP	4,897,708	01/30/90	Clements						
75	4,983,251	01/08/91	Haisma et al.						

### **FOREIGN PATENT DOCUMENTS**

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
RSP	DE 32 33 195	03/17/83	Germany				
PEP	JP S60-126871	07/06/85	Japan				
RED	JP S63-229862	09/26/88	Japan				
FOR	EP 0 314 437	05/03/89	EPO				
PRP	JP H01-199476	08/10/89	Japan				
Ref	JP H03-284871	12/16/91	Japan				
FAP	WO 92/03848	03/05/92	РСТ				
450	JP 04-076946	03/11/92	Japan				
Res	WO 01/05366	01/25/01	PCT				

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.) **EXAMINER** INITIAL

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PTO/SB/08A (10-01)

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Approved for use through 10/31/2002. OMB 0651-0031 U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

Under the paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB

Substitu	ite for form 144	19/PT	0	Complete if known			
				Application Number	10/766,557		
INFO	PRMATION	DISC	CLOSURE	Filing Date	January 27, 2004		
STATEMENT BY APPLICANT				First Named Inventor	Glenn J. Leedy		
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(use as many sheets as necessary)			necessary)	Examiner Name	Not Yet Assigned		
Sheet	1	of	1	Attorney Docket Number	ELM-1 CONT.14		

		U.S	S. PATENT DO	CUMENTS	
Examiner		Document Number	Publication Date	Name of Patentee or	Pages, Columns, Lines, Where Relevant Passages or Relevant
initials*	No.¹	Number - Kind Code <sup>2</sup> (if known)	MM-DD-YYYY	Applicant of Cited Documents	Figures Appear
HOP		US-4,835,765	05/30/1989	Bergmans et al.	
F)		US-4,919,749	04/24/1990	Mauger et al.	
<b>A</b>		US-5,144,142	09/01/1992	Fueki et al.	
4		US-5,262,341	11/16/1993	Fueki et al.	

FOREIGN PATENT DOCUMENTS								
Examiner	Cite	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Documents	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	76		
Initials No.		Country Code 1 - Nurriber 2 - Kind Code 3				1		
W CH		JP-127816	05-30-1991	Japan				
REY		JP-174715	07-29-1991	Japan				
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		NON PATENT LITERATURE DOCUMENTS			
Examiner Initials Cite No.1 Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the litem (book, magazine, journal, serial, symposium, calalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published					
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All References Have Been Considered:	
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Applicant's unique citation designation number (optional). See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. Applicant is to place a check mark here if English language translation is attached.

PTO/SB/08A (10-01)

Approved for use through 10/31/2002. OMB 0651-0031
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				Application Number	10/766,557 (Conf. No.: 3092)	
INFO	<b>PRMATION</b>	DISC	CLOSURE	Filing Date	January 27, 2004	
STATEMENT BY APPLICANT			PLICANT	First Named Inventor	Glenn J. Leedy	
				Art Unit	2812	
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Sheet	1	of	1	Attorney Docket Number	ELM-1 CONT.14	

	U.S. PATENT DOCUMENTS									
Examiner Cite	Document Number	Publication Date	Name of Patentee or	Pages, Columns, Lines, Where Relevant Passages or Relevant						
Initials*	No.1	Number – Kind Code <sup>2</sup> (if known)	MM-DD-YYYY	Applicant of Cited Documents	Figures Appear					
100		6,230,233	05/08/2001	Lofgren et al.						
TE TE		6,445,006	09/03/2002	Brandes et al.						
は代		6,682,981	01/27/2004	Leedy						
70		6,713,327	03/30/2004	Leedy						

	FOREIGN PATENT DOCUMENTS					
Examiner	Cite	Foreign Patent Document		Name of Patentee or	Pages, Columns, Lines, Where Relevant	
initials		Country Code 1 - Number 2 - Kind Code 3		Applicant of Cited Documents	Passages or Relevant Figures Appear	Τ <sup>6</sup>
A	1	JP S63-076484	04/06/1988	Suzuno et al.		
250		EP 0 518 283	12/16/1992	Kawagishi et al.		
FEA	}	WO 03/078305	09/25/2003	Viefers et al.		
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NON PATENT LITERATURE DOCUMENTS					
Examiner initials	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-Issue number(s), publisher, city and/or country where published	1'8		
RP		Sung, et al., "Well-aligned carbon nitride nanotubes synthesized in anodic alumina by electron cyclotron resonance chemical vapor deposition," Applied Physics Letters, Volume 74, Number 2, 197, 1999, January 11, 1999.			
म्ब		Phys. Rev., B, Condens, Matter Mater. Phys. (USA), Physical Review B (Condensed Matter and Materials Physics), 15 March 2003, APS through AIP, USA.			
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		Application Number 10/766,557 (Conf. N			
INFO	INFORMATION DISCLOSURE		Filing Date	January 27, 2004	
STATEMENT BY APPLICANT		First Named Inventor	Glenn J. Leedy		
	STATEMENT BY AFFEIGANT			Art Unit	2812
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Sheet	1	of	1	Attorney Docket Number	ELM-1 CONT.14

	U.S. PATENT DOCUMENTS					
Examiner		Document Number	Publication Date	Name of Patentee or	Pages, Columns, Lines, Where Relevant Passages or Relevant	
initials*	No.1	Number – Kind Code <sup>2</sup> (if known)	MM-DD-YYYY	Applicant of Cited Documents	Figures Appear	
45		4,724,328	02/09/1988	Lischke		
Pep		4,994,336	02/19/1991	Benecke et al.		
ASP		5,358,909	10/25/1994	Hashiguchi et al.		
1272		5,514,628	05/07/1996	Enomoto et al.		
4CP		5,620,915	04/15/1997	Chen et al.		
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	FOREIGN PATENT DOCUMENTS					
Examiner Cite initials No.	Cite	Foreign Patent Document		Name of Patentee or	Pages, Columns, Lines, Where Relevant	6
	No.1	Country Code <sup>1</sup> - Number <sup>2</sup> - Kind Code <sup>3</sup>		Applicant of Cited Documents	Passages or Relevant Figures Appear	
W.		GB 2,125,168	02/29/1984	Kouno		
80		JP 02-037655	02/07/1990	Benecke et al.		

		NON PATENT LITERATURE DOCUMENTS	-
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ROP		"Christensens Physics of Diagnostic Radiology," Curry et al., pp.29-33, 1990.	
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All References Have Been Considered:		
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Complete if known Synostitute for form 1449/PTO 10/766,557 (Conf. No.: 3092) **Application Number** January 27, 2004 INFORMATION DISCLOSURE Filing Date **First Named Inventor** Glenn J. Leedy STATEMENT BY APPLICANT **Art Unit** 2812 Not Yet Assigned **Examiner Name** (use as many sheets as necessary) of ELM-1 CONT.14 **Attorney Docket Number** Sheet

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Examiner	Cite	Document Number	Publication Date	. Name of Patentee or	Pages, Columns, Lines, Where Relevant Passages or Relevant
initials*	No.1	Number - Kind Code <sup>2</sup> (if known)	MM-DD-YYYY	Applicant of Cited Documents	Figures Appear
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	U.S. PATENT DOCUMENTS						
Examiner	0	Document Number	Publication Date	Name of Patentee or	Pages, Columns, Lines, Where		
Initials*	Cite No.1	Number-Kind Code <sup>2</sup> ( if known)	MM-DD-YYYY	Applicant of Cited Document	Relevant Passages or Relevant Figures Appear		
129	•	US 4,604,162	08-05-1986	Sobczak			
1		US 4,849,857	07-18-1989	Butt et al.			
		US 4,928,058	05-22-1990	Williamson			
		US 4,990,462	02-05-1991	Sliwa			
		US 5,110,712	05-05-1992	Kessler et al.			
		US 5,119,164	06-02-1992	Sliwa et al.			
		US 5,284,804	02-08-1994	Moslehi			
		US 5,480,842	01-02-1996	Clifton et al.			
		US 5,470,693	11-28-1995	Sachdev et al.			
		US 5,733,814	03-31-1998	Flesher et al.			
780		US Re 37,637	04-09-2002	Clifton et al.			

		FOREIG	GN PATENT	DOCUMENTS		
Examiner	Cite	Foreign Patent Document	Publication Date	Name of Patentee or	Pages, Columns, Lines, Where Relevant Passages	
Initials*	No.1	Country Code <sup>3</sup> -Number <sup>4</sup> -Kind Code <sup>6</sup> (if known)	MM-DD-YYYY	Applicant of Cited Document	or Relevant Figures Appear	
Ro		EP 0 201 380 B1	12-17-1986	Fairchild Semiconductor Corporation		
PSP	l	EP 0 224 418 B1	06-03-1987	Fujitsu Limited		
180		EP 0 419 898 B1	04-03-1991	Siemens Aktiengesellschaft		
Æço.		EP 0 455 455 B1	11-06-1991	AT&T Corp.		
دکم		EP 0 487 302 B1	05-27-1992	Shin-ETSU Handotai		
<b>₹</b>		EP 0 407 302 BT		Company Limited		
1800		EP 0 503 816 B1	09-16-1992	Shin-ETSU Handotai		
	Ì	EF 0 303 616 B1		Company Limited		
780	l	EP 0 518 774 B1	12-16-1992	France Telecom		
780		EP 0 526 551 B1	02-10-1993	The Commonwealth of Australia		
<b>⊅\$</b> ∞		EP 0 554 063 B1	08-04-1993	Canon Kabushiki Kaisha		
<b>₹</b>	-	EP 0 555 252 B1	08-18-1993	Fraunhoffer-Gesellschaft Zur Förderung Der Angewandten Forschung E.V		
160		WO 1989 010255	11-02-1989	3D Systems Inc.		
7000		WO 1990 009093		Polylithics Inc.		
Bo		WO 1992 017901	10-15-1992	Integrated System Assemblies Corporation		

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Substitute for form 1448/CAF TO				Application Number	10/766,557	(Conf. No. 3092)	
	NFORMATIO	n disc	CLOSURE	Filing Date	January 27, 2004		
	STATEMENT BY APPLICANT			First Named Inventor	Glenn J. Leedy		
				Art Unit	2812		
	(Use as many sheets as necessary)			Examiner Name	Amir Zarabian		
Shee	1 2	of	3	Attorney Docket Number	ELM-1 Cont.1	4	

		NON PATENT LITERATURE DOCUMENTS	
Examiner Initials	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T²
20		Jones, R.E., Jr. "An evaluation of methods for passivating silicon integrated circuits"; April 1972; pp. 23-8	
80		Svechnikov, S.V.; Kobylyatskaya, M.F.; Kimarskii, V.I.; Kaufman, A.P.; Kuzovlev, Yu. I.; Cherepov, Ye. I.; Fomin, B.I.; "A switching plate with aluminum membrane crossings of conductors"; 1972	
<b>%</b>		Sun, R.C.; Tisone, T.C.; Cruzan, P.D.; "Internal stresses and resistivity of low-voltage sputtered tungsten films (microelectronic cct. conductor)"; March 1973; pp. 1009-16	
100 mg		Wade, T.E.; "Low temperature double-exposed polyimide/oxide dielectric for VLSI multilevel metal interconnection"; 1982; pp. 516-19	
8		Boyer, P.K.; Collins, G.J.; Moore, C.A.; Ritchie, W.K.; Roche, G. A.; Solanski, R. (A); Tang, C.C.; "Microelectronic thin film deposition by ultraviolet laser photolysis MONOGRAPH TITLE - Laser processing of semiconductor devices"; 1983; pp. 120-126	
6×		Boyer, P.K.; Moore, C.A.; Solanki, R.; Ritchie, W.K.; Roche, G.A.; Collins, G.J.; "Laser photolytic deposition of thin films"; 1983; pp. 119-27	
80	-	Chen, Y.S.; Fatemi, H.; "Stress measurements on multilevel thin film dielectric layers used in Si integrated circuits"; May-June 1986; pp. 645-9	
3		Salazar, M.; Wilkins, C.W., Jr.; Ryan, V.W.; Wang, T.T.; "Low stress films of cyclized polybutadiene dielectrics by vacuum annealing"; Oct. 21-22, 1986; pp. 96-102	
40		Townsend, P.H.; Huggins, R.A.; "Stresses in borophosphosilicate glass films during thermal cycling"; Oct. 21-22, 1986; pp. 134-41	
<b>P</b>		Pai, Pei-Lin; "Multilevel Interconnection TechnologiesA Framework And Examples"; 1987; pp. 1871	
Bo		Pei-lin Pai; Chetty, A.; Roat, R.; Cox, N.; Chiu Ting; "Material characteristics of spin-on glasses for interlayer dielectric applications"; November 1987, pp. 2829-34	
\$		Allen, Mark G.,; Senturia, Stephen D.; "Measurement of polyimide interlayer adhesion using microfabricated structures"; 1988; pp. 352-356	
XS.		Chang, E.Y.; Cibuzar, G.T.; Pande, K.P.; "Passivation of GaAs FET's with PECVD silicon nitride films of different stress states"; September 1988; pp. 1412-18	
RO		Riley, P.E.; Shelley, A.; "Characterization of a spin-applied dielectric for use in multilevel metallization"; May 1988; pp. 1207-10	
R	,	Tamura, H.; Nishikawa, T.; Wakino, K.; Sudo, T.; "Metalized MIC substrates using high K dielectric resonator materials"; October 1988; pp. 117-126	
80		Kochugova, I.V.; Nikolaeva, L.V.; Vakser, N.M., (M.I. Kalinin Leningrad Polytechnic Institute (USSR); "Electrophysical investigation of thin-layered inorganic coatings"; 1989; pp. 826-828	
Pap		Reche, J.J. H.; "Control of thin film materials properties used in high density multichip interconnect"; April 24-28, 1989; p. 494	

	<i></i>			
Examiner			Date	11/21/00
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PTO/SB/08a/b (08-03)
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Substitute for form 1449A/B/PTO			Complete if Known				
			Application Number	10/766,557	(Conf. No. 3092)		
INF	FORMATIC	ON DIS	CLOSURE	Filing Date	January 27, 2004		
ST	STATEMENT BY APPLICANT			First Named Inventor	Glenn J. Leedy		
				Art Unit	2812		
(Use as many sheets as necessary)			Examiner Name	Amir Zarabian			
Sheet	3	of	3	Attorney Docket Number	ELM-1 Cont.1	4	

		NON PATENT LITERATURE DOCUMENTS	
Examiner Initials	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T²
Por	>	Maw, T.; Hopla, R.E.; "Properties of a photoimageable thin polyimide film"; Nov. 26-29-, 1990; pp. 71-6	
Per	7	Draper, B. L.; Hill, T.A.; "Stress and stress relaxation in integrated circuit metals and dielectrics"; July-Aug. 1991; pp. 1956-62	
RVD	`	Guckel, H.; "Surface micromachined pressure transducers"; 1991; pp. 133-146	
R	, , ,	Garino, T.J.; Harrington, H. M.; "Residual stress in PZT thin films and its effect on ferroelectric properties'; 1992; pp. 341-7	

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